

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT7661274

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DONG WOO JEONG	11/10/2022
EUN SUE KIM	11/11/2022
DAE HEE LEE	11/10/2022
MYUNG HOE KIM	11/10/2022
JUN SIK HWANG	10/06/2022
GWON HWA BOK	10/06/2022
HAE DONG KWAK	10/06/2022
JAE SUNG SHIN	10/06/2022
HAN KYUNG PARK	10/06/2022
JAE HOON CHO	10/06/2022
RECEIVING PARTY DATA	
Name:	HYUNDAI MOTOR COMPANY
Street Address:	12, HEOLLEUNG-RO, SEOCHO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	06797
Name:	KIA CORPORATION
Street Address:	12, HEOLLEUNG-RO, SEOCHO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	06797
Name:	HYUNDAI TRANSYS INC.
Street Address:	105, SINDANG 1-RO, SEONGYEON-MYEON
City:	SEOSAN-SI, CHUNGCHEONGNAM-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	31930
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17993476

CORRESPONDENCE DATA**Fax Number:** (415)442-1001

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 4154421000**Email:** GERALDINE.RUIZ@MORGANLEWIS.COM**Correspondent Name:** MORGAN, LEWIS & BOCKIUS LLP**Address Line 1:** ONE MARKET, SPEAR STREET TOWER**Address Line 2:** SUITE 2800**Address Line 4:** SAN FRANCISCO, CALIFORNIA 94105

ATTORNEY DOCKET NUMBER:	060943-5672-US
NAME OF SUBMITTER:	GERALDINE RUIZ
SIGNATURE:	/Geraldine Ruiz/
DATE SIGNED:	11/23/2022

Total Attachments: 5

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ASSIGNMENT
(Joint Inventors)

WHEREAS, the undersigned, (1) **JEONG, Dong Woo**, resident 110-1804, 106 Gwanmun-ro, Gwacheon-si, Gyeonggi-do, 13804, Republic of Korea, and (2) **KIM, Eun Sue**, resident of 1466-304, 122 Dongtandaeosibeom-gil, Hwaseong-si, Gyeonggi-do, 18476, Republic of Korea, (3) **LEE, Dae Hee**, resident of 1307-801, 75 Art center-daero 97beon-gil, Yeonsu-gu, Incheon, 22002, Republic of Korea, and (4) **KIM, Myung Hoe**, resident of 206-1401, 34 Seocho-daero 1-gil, Seocho-gu, Seoul, 06566, Republic of Korea, (5) **HWANG, Jun Sik**, resident of 11 Dongtan-daero 24-gil, Hwaseong-si, Gyeonggi-do, 18463, Republic of Korea, and (6) **BOK, Gwon Hwa**, resident of 11 Dongtan-daero 24-gil, Hwaseong-si, Gyeonggi-do, 18463, Republic of Korea, (7) **KWAK, Hae Dong**, resident of 11 Dongtan-daero 24-gil, Hwaseong-si, Gyeonggi-do, 18463, Republic of Korea, and (8) **SHIN, Jae Sung**, resident of 11 Dongtan-daero 24-gil, Hwaseong-si, Gyeonggi-do, 18463, Republic of Korea, (9) **PARK, Han Kyung**, resident of 11 Dongtan-daero 24-gil, Hwaseong-si, Gyeonggi-do, 18463, Republic of Korea, and (10) **CHO, Jae Hoon**, resident of 11 Dongtan-daero 24-gil, Hwaseong-si, Gyeonggi-do, 18463, Republic of Korea (hereinafter termed "Inventors"), respectively, have invented certain new and useful improvements in *VEHICLE SEAT* and executed therefore an application for Letters Patent of the United States and

- ☒ having an oath or declaration executed on even date herewith.
☐ bearing U.S. Patent Application No. _____ and filed on _____.

WHEREAS, **Hyundai Motor Company**, a corporation of the Republic of Korea, having a place of business at 12, Heolleung-ro, Seocho-gu, Seoul, 06797, Republic of Korea, **Kia Corporation**, a corporation of the Republic of Korea, having a place of business at 12, Heolleung-ro, Seocho-gu, Seoul, 06797, Republic of Korea, and **Hyundai Transys Inc.**, a corporation of the Republic of Korea, having a place of business at 105, Sindang 1-ro, Seongyeon-myeon, Seosan-si, Chungcheongnam-do, 31930, Republic of Korea (hereinafter termed "Assignee"), is desirous of acquiring the entire right, title and interest of said Inventors in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter termed "patents") thereon granted in the United States and foreign countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; and (d) in and to each and every reissue or

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division, substitution, or continuation of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.

2. Said Inventors do hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

4. Said Inventors do hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventors have executed and delivered this instrument to said Assignee as follows:

(1) JEONG, Dong Woo

Date: November 10, 2022

By: Jeong Dongwoo

(2) KIM, Eun Sue

Date: November 10, 2022

By: _____

(3) LEE, Dae Hee

Date: November 10, 2022

By: LEE Dae Hee

PATENT

Attorney Docket No. _____

extensions of any of said patents.

2. Said Inventors do hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

4. Said Inventors do hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventors have executed and delivered this instrument to said Assignee as follows:

(1) JEONG, Dong Woo

Date: November 11, 2022

By: _____

(2) KIM, Eun Sue

Date: November 11, 2022

By: KIM, Eun Sue

(3) LEE, Dae Hee

Date: November 11, 2022

By: _____

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Attorney Docket No. _____

Date: <u>November 10, 2022</u>	(4) KIM, Myung Hoe By: <u><i>Kim Myung Hoe</i></u>
Date: <u>November 10, 2022</u>	(5) HWANG, Jun Sik By: _____
Date: <u>November 10, 2022</u>	(6) BOK, Gwon Hwa By: _____
Date: <u>November 10, 2022</u>	(7) KWAK, Hae Dong By: _____
Date: <u>November 10, 2022</u>	(8) SHIN, Jae Sung By: _____
Date: <u>November 10, 2022</u>	(9) PARK, Han Kyung By: _____
Date: <u>November 10, 2022</u>	(10) CHO, Jae Hoon By: _____

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Attorney Docket No. _____

(4) KIM, Myung Hoe

Date: October 6, 2022

By: _____

(5) HWANG, Jun Sik

Date: October 6, 2022

By: Hwang Jun Sik

(6) BOK, Gwon Hwa

Date: October 6, 2022

By: [Signature]

(7) KWAK, Hae Dong

Date: October 6, 2022

By: [Signature]

(8) SHIN, Jae Sung

Date: October 6, 2022

By: [Signature]

(9) PARK, Han Kyung

Date: October 6, 2022

By: [Signature]

(10) CHO, Jae Hoon

Date: October 6, 2022

By: [Signature]